

FINE series PURE®

Flow Control System

FCS® *Pressure Series*



Towards the New Horizon

Fujikin's FCS® (Flow Control System) Series leads the way in flow control technology.

Fluctuations in the supply pressure have little effect on the control flow rate.

Quick response time of 0.5 msec or less.

Equipped with the Multi Gas / Multi Range (MGMR) function.

*Can be mounted in any attitude or position.
(Free mounting position)*

Incorporates flow rate self-diagnosis function.



Developed to enhance stability and repeatability during etch and deposition, the most critical steps in semiconductor wafer manufacturing, the FCS® differs dramatically from conventional mass flow controllers (MFC) in its very theory of operation.

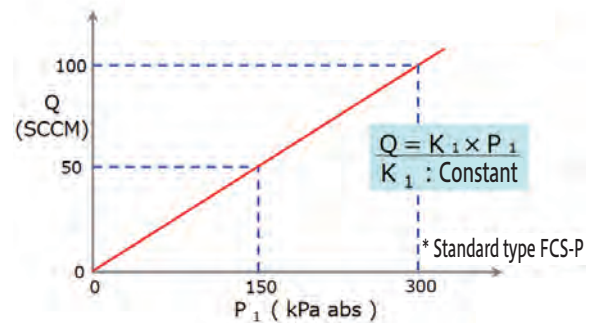
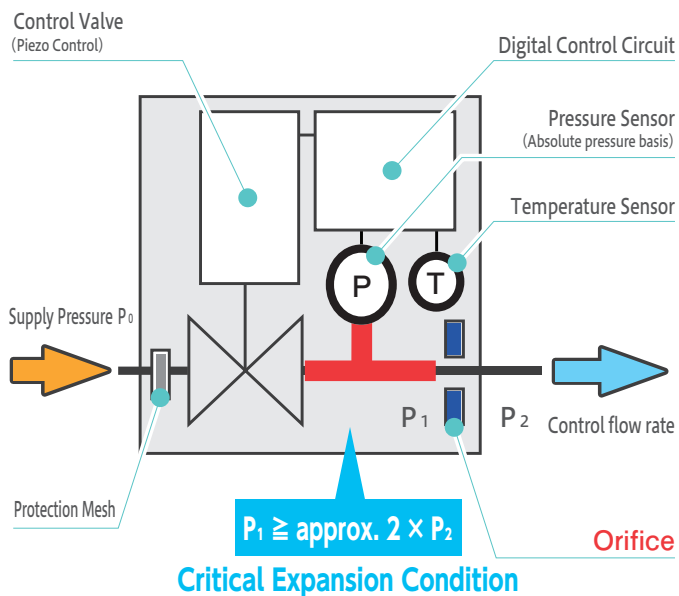
By developing the FCS® around non-conventional methods, highly accurate flow control is achieved – accuracy that is impossible to achieve with traditional pressure-based MFCs.

The FCS® overcomes unstable process variations such as pressure fluctuations (hunting) and crosstalk in gas supply systems and provides an unlimited amount of flow control stability.

In addition, the high accuracy of the FCS® matches the state-of-the-art in semiconductor manufacturing and is therefore one of the FCS®'s most appealing features.

The FCS® promises the highest level of performance.

● Basic Structure and Operating Principle of FCS®



When orifice downstream pressure P_2 is 1 kPa or less

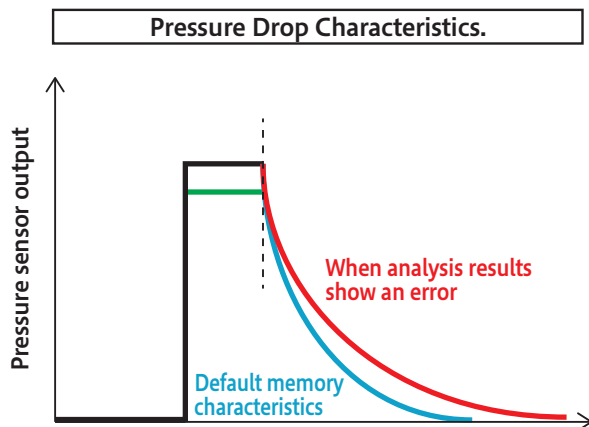
$P_1 = 2$ kPa abs.	→	Flow rate: 10 SCCM
$P_1 = 20$ kPa abs.	→	Flow rate: 100 SCCM
$P_1 = 200$ kPa abs.	→	Flow rate: 1000 SCCM

● Flow Rate Self-diagnosis Function

Memorizes pressure drop characteristics.

Compares with the normal state (default values).

Analyzes failures and estimates the cause of failure.



Default Memory

After the control flow rate is set to the specified value by the FCS-P itself, the control valve is closed, and the characteristics between the pressure sensor output and time are saved in the CPU. (The initial reference characteristics memory: N_2 gas is the default.)

Flow Rate Self Diagnosis

When the gas used in the default memory is flown, the FCS-P is triggered by the flow rate diagnosis start signal and starts adjusting the control flow rate to the specified value. Then the control valve is closed, the characteristics between the pressure sensor output and time are compared with the default memory characteristics, and diagnosis results are obtained.

If an error is detected in the diagnosis results, an alarm ("diagnosis result error") is issued.

For example, if there is a clogging, the diagnosis result shows positive.

FCSP7300

series



- *Possible to monitor the supply pressure based on the response time!*
- *Response time is 500 mm/sec or less!*
- *Multi Gas / Multi Range (MGMR) supported!*

General Specifications

Flow Rate Range (N ₂ Equivalent)	10 SCCM – 4 SLM
Flow Rate Accuracy	≤ ±1.0% S.P. (Setting signal: 10 to 100% [when controlling differential pressure: 10 to 19.7%])
	≤ ±0.1% F.S. (Setting signal: 1 to 10% [when controlling differential pressure: 4 to 10%])
Response Time (N ₂)*	≤500 msec
Supply Pressure (F.S. Flow Rate)	250 – 898.7 kPaG
Downstream Pressure	≤200 Torr
Permissible Operating Temperature Range	0 – 50 °C
Communication System	DeviceNet™, EtherCAT®

* Within 500 msec to reach to ±2.0% of the setting value (Setting value: 10 to 100%)

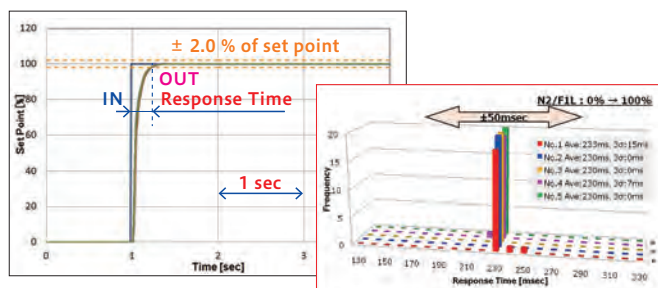
Note 1: Flow rates (SCCM, SLM) are converted to values at 0°C and 101.3 kPa abs (1 atm) for calibration.

Note 2: Supported ranges and usable gases are limited. Check each time as required.

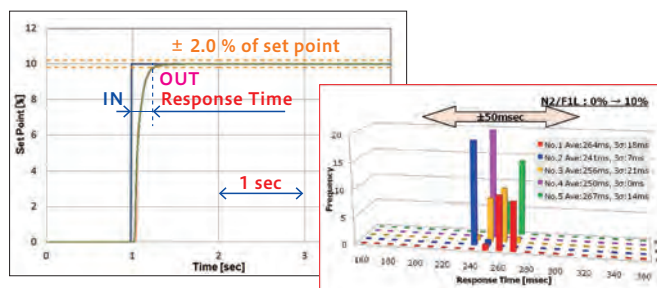
Note 3: When using RS485, please contact Fujikin.

Response Time

N₂ gas/1,000 SCCM F.S.: 0% → 100% response waveform

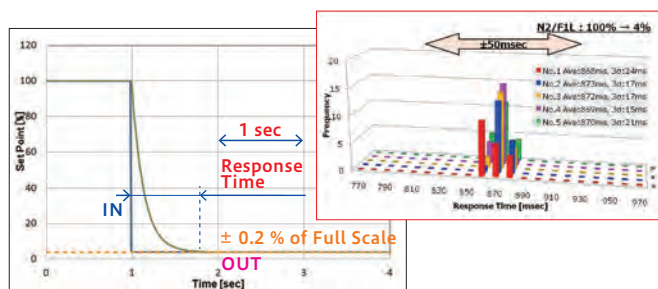


N₂ gas/1,000 SCCM F.S.: 0% → 10 % response waveform



Within ±50 msec of actual value,
variation (3σ)

N₂ gas/1,000 SCCM F.S.: 100 % → 4 % response waveform



Flow Rate Range (N₂ Equivalent)

- Multi Gas / Multi Range (MGMR) supported (Full scale flow rate turn-down: 50%)
- Flow rate range (BIN): Total 9 types / Full scale flow rate 10 SCCM to 4 SLM [N₂ equivalent]

Bin Size	N ₂	Flow Rate Range
Bin1	10 – 20 SCCM	10 SCCM, 20 SCCM
Bin2	21 – 40 SCCM	30 SCCM, 40 SCCM
Bin3	41 – 80 SCCM	43 SCCM, 50 SCCM, 65 SCCM, 80 SCCM
Bin4	81 – 160 SCCM	100 SCCM, 110 SCCM, 130 SCCM, 160 SCCM
Bin5	161 – 300 SCCM	200 SCCM, 210 SCCM, 260 SCCM, 300 SCCM
Bin6	301 – 600 SCCM	400 SCCM, 450 SCCM, 500 SCCM, 600 SCCM
Bin7	601 – 1000 SCCM	850 SCCM, 1000 SCCM
Bin8	1001 – 2000 SCCM	1300 SCCM, 1600 SCCM, 2000 SCCM
Bin9	2001 – 4000 SCCM	2400 SCCM, 3000 SCCM, 4000 SCCM

Ultra Compact FCS-P



- *Achieves the width of 10.2mm and supports the increase in the number of gas systems.*
- *Flow rate accuracy: ± 1.0 % S.P. (Multi Gas / Multi Range)*
- *Response time is 500 msec or less!*

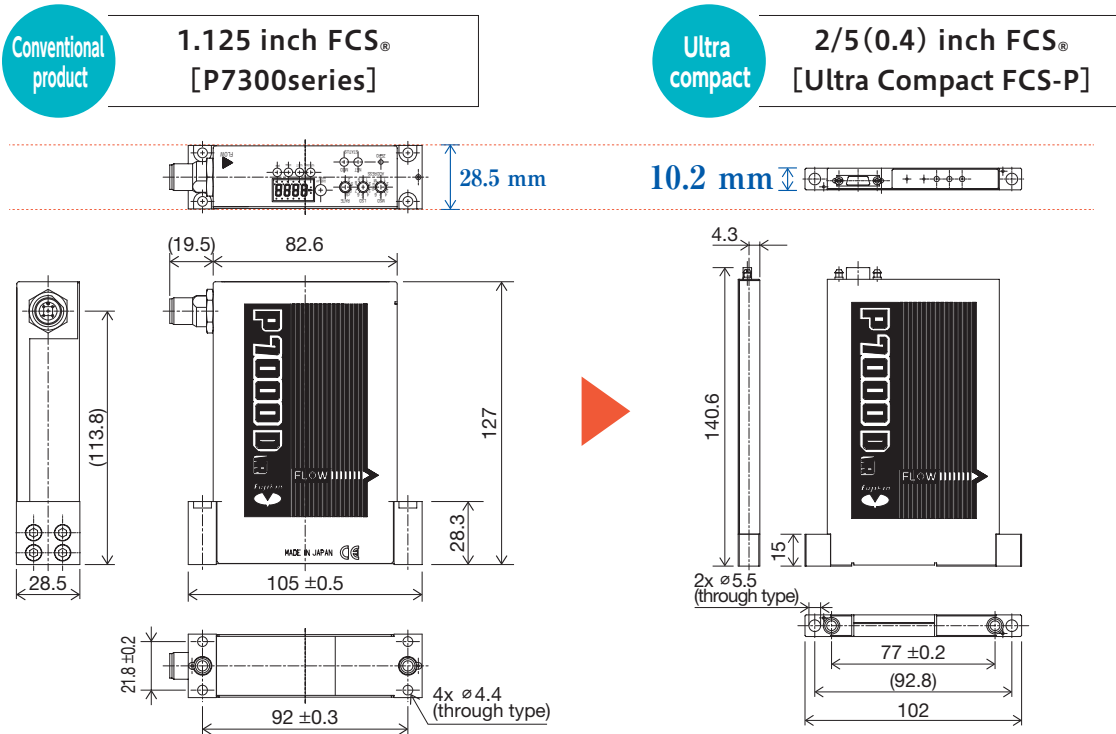
General Specifications

Flow Rate Range (N ₂ Equivalent)		10 – 1300 SCCM
Flow Rate Accuracy	Standard Type	≒ ±1.0% S.P. (Setting signal: 10 to 100% [when controlling differential pressure: 10 to 19.7%])
		≒ ±0.1% F.S. (Setting signal: 1 to 10% [when controlling differential pressure: 4 to 10%])
	Low Pressure (B) Type	≒ ±1.0% S.P. (Setting signal: 20 to 100% [when controlling differential pressure: 20 to 45.1%])
		≒ ±0.2 % F.S. (Setting signal: 2 to 20 % [when controlling differential pressure: 10 to 20%])
Response Time (N ₂ rising characteristics)*		≒500 msec
Supply Pressure (F.S. Flow Rate)	Standard Type	250 – 898.7 kPaG
	Low Pressure (B) Type	50 – 898.7 kPaG
Downstream Pressure		≒200 Torr
Permissible Operating Temperature Range		0 – 50 °C
Communication System		DeviceNet™, EtherCAT®

* Within 500 msec up to $\pm 2\%$ S.P. of the setting value or $\pm 0.2\%$ F.S. (whichever is larger).

Note 1: Flow rates (SCCM, SLM) are converted to values at 0°C and 101.3 kPa abs (1 atm) for calibration.

Size Comparison

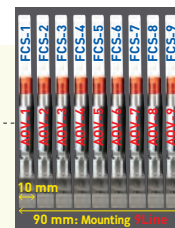


Comparison of Mounted Gas Lines

The compact FCS-P has **three times larger number of gas lines** compared with the conventional 1.125-inch FCS®.



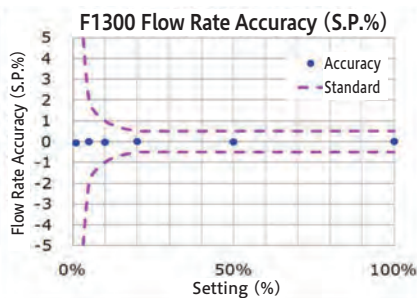
1.125 inch FCS®
3 LINE



Ultra Compact FCS-P
9 LINE

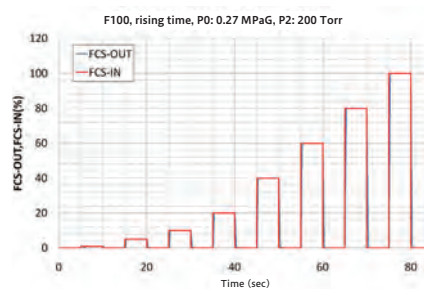
Flow Rate Accuracy

F1300 Flow Rate Accuracy (S.P.%)

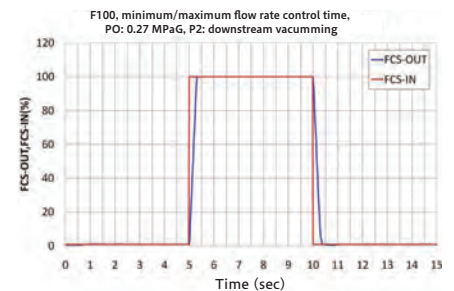


Response Time

F100, rising time, P0: 0.27 MPaG, P2: 200 Torr



F100, minimum/maximum flow rate control time, P0: 0.27 MPaG, P2: downstream vacuuming



FCSP8000

series



- **Range ability: 1000:1**
- **Guarantees the flow rate accuracy of $\pm 1.0\%$ S.P.!**



General Specifications

Flow Rate Range (N ₂ Equivalent)	3.3 SCCM – 3.2 SLM
	[Small flow rate range: 3.3 to 160 SCCM, Large flow rate range: 160 SCCM to 3.2 SLM]
Flow Rate Accuracy	$\leq \pm 1.0\%$ S.P. (8 SCCM – 3.2 SLM)
	$\leq \pm 0.1\%$ F.S. (3.3 – 8 SCCM)
Response Time (N ₂ rising characteristics)*	≤ 0.5 sec (≤ 2.0 sec 5% F.S. or less)
Response Time (N ₂ falling characteristics)*	≤ 1.0 sec (5 to 100% F.S.) ≤ 2.0 sec (less than 5% F.S.)
Supply Pressure (F.S. Flow Rate)	250 – 898.7 kPaG
Downstream Pressure	≤ 400 Torr
Permissible Operating Temperature Range	0 – 50 °C
Communication System	DeviceNet™

* Within 0.5 sec up to $\pm 2\%$ S.P. of the setting value or $\pm 0.05\%$ F.S. (whichever is larger).

Note 1: Flow rates (SCCM, SLM) are converted to values at 0°C and 101.3 kPa abs (1 atm) for calibration.

Auto Pressure Controller

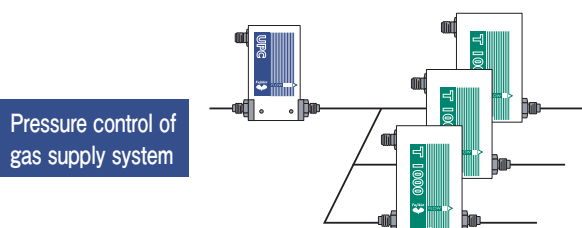


● Operating Principle

The UPC® Series controllers keep the pressure constant using a built-in pressure sensor.

● Application

- Any pressure can be set using an electrical signal.
- Connecting a UPC® Series controller to the upstream side of a Mass Flow Controller (MFC) makes extremely stable flow control possible.
- When two or more MFCs are connected in one line and a rapid change in gas flow rate occurs on one of them, the other MFCs may sometimes be affected.
This can be prevented by using a UPC® Series controller (downstream pressure controller).
- The UPCUS® (upstream pressure controller) keeps constant the internal pressure of the liquid source tank of an MO-CVD system, for example, to improve the vaporization stability in amount of a liquid source.
- Can be used as a controller for cooling wafer rear surfaces.
- High temperature type (for max. 150 ° C and max. 250 ° C) and a model with a flow monitor are also available from the product lineup.



〈Part Number Designation〉

UPC Analog I/O Downstream pressure control - **4J2C** Face-to-face dimension: 124 mm Piping height: 12.7 mm - **C150** Full scale pressure range: 150 kPa abs. **L** Control valve Cv value: 0.0055

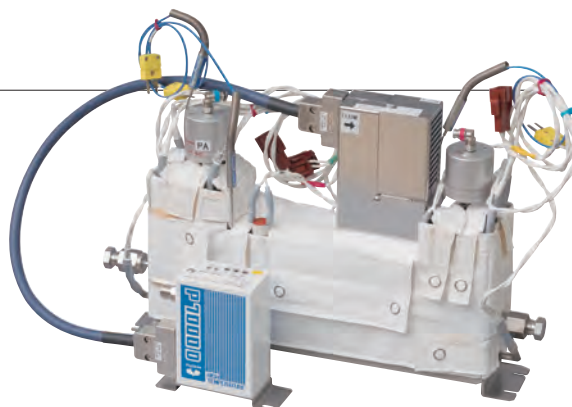
■ General Specifications

Model Number	UPC® (Downstream pressure controller)		UPCUS® (Upstream pressure controller)
Pressure Range	F.S. 13.3 kPa abs. (100 Torr)	F.S. 150/300/500 kPa abs.	
Control Pressure Range	1 - 100 %	1 - 100 % *1	
Control Valve Cv Value	—————	L type: 0.0055 / M Type: 0.011 / H Type: 0.03	
Pressure Adjusting Accuracy (After auto zeroing)	1 - 40 %: ±0.2 % F.S. 40 - 100 %: ±0.5 % S.P.	F.S.150 kPa abs. [1 - 40 %: ±0.2 % F.S., 40 - 100 %: ±0.5 % S.P.] F.S.300/500 kPa abs. [1 - 20 %: ±0.1 % F.S., 20 - 100 %: ±0.5 % S.P.]	
Maximum Pressure	200 kPaG	1 MPaG	
Permissible Operating Temperature Range	0 - 50 °C (Accuracy guaranteed temperature range: 15 - 35° C) *2		
Pressure Setting / Output Signal	Analog: 0.1 - 10 VDC/0 - 10 VDC (Supply power voltage: ±15 VDC) Digital: DeviceNet™	Analog: 0.05 - 5 VDC/0 - 5 VDC (Supply power voltage: ±15 VDC) Digital: DeviceNet™	

*1: Control range: The pressure control range of the UPCUS® changes under different conditions. Please consult Fujikin for more information.

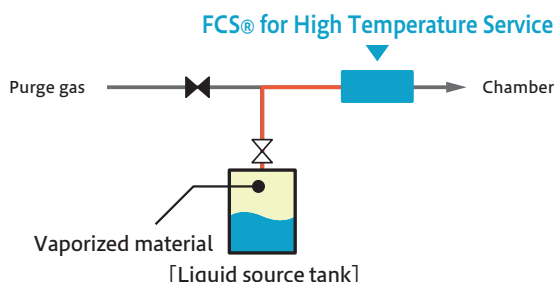
*2: Options available for temperature specifications of 50 °C. Please consult Fujikin for more information.

FCS[®] & FALVS[®] for High Temperature Service



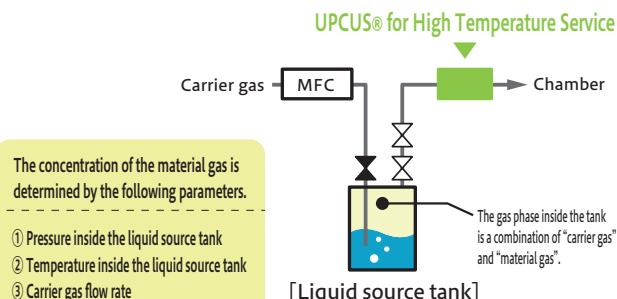
FCS[®] for High Temperature Service

FCS[®] for High Temperature Service controls the flow rate of vapor generated in a tank.



UPCUS[®] for High Temperature Service

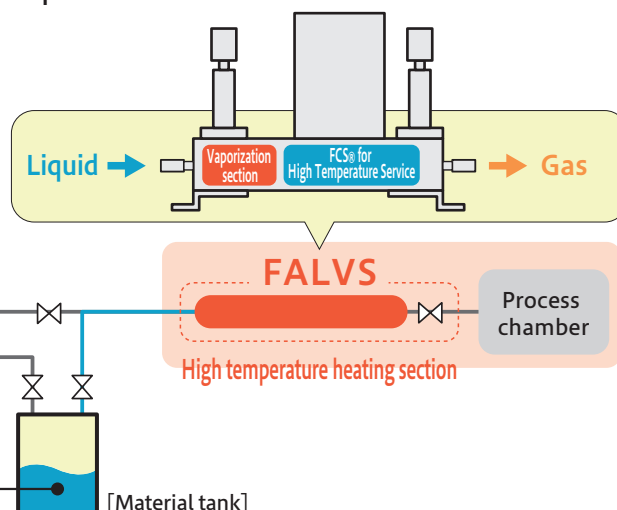
Used for bubbling supply and precisely controls the pressure inside the tank.



FALVS[®]

The FALVS[®] (Fujikin Advance Liquid Vaporize System) is a system designed to vaporize a liquid material and to precisely control the vapor flow rate with the FCS[®] for High Temperature Service.

- **Vaporizes 100% at the vaporization section.**
The FCS[®] for High Temperature Service controls the flow rate of vaporized material.
 - Prevents reliquefaction or solidification (precipitation) of material.
 - Particle free
- **Realizes no carrier gas.**
 - Reduces costs and environmental loads.
- **Achieves highly accurate flow control.**
 - Improved process reliability
 - Compact



FFMS

Flow Measurement System

- *Prevention of process problems!*
- *Checking repeatability of a mass flow controller!*



IGS®



- *Downsizing!*
- *Improved installation and maintenance workability!*

Part Number Designation

FCSP7302

FCS P7302 D W2 L - T5 - 4CW2 - F300 / N2 - B5 D **

FLOW CONTROL SYSTEM	①	②	③	④	⑤	⑥	⑦	⑧	⑨	⑩
	① Series		③ Control range		⑤ Accuracy guaranteed temperature range		⑦ Full scale		⑨ Bin No.	⑩ Function
	② Communication D: DeviceNet™ E: EtherCAT [®]		W2: Wide range 200 Torr	④ LCD display PO sensor None: Provided L: Not provided	⑥ Fitting type, face-to-face dimension or seal pitch 4CW2: 1.125, Wseal [®] Seal pitch: 92 mm 4CC2: 1.125, Cseal Seal pitch: 92 mm		⑧ Gas name Chemical formula		B1: 10-20 SCCM B2: 21-40 SCCM B3: 41-80 SCCM B4: 81-160 SCCM B5: 161-300 SCCM B6: 301-600 SCCM B7: 601-1000 SCCM B8: 1001-2000 SCCM B9: 2001-4000 SCCM (N ₂ Equivalent)	D**: E**: Numerals are entered in "****".

FCS P7302 E W2-4TW1-F20 B / N2-B1 E **

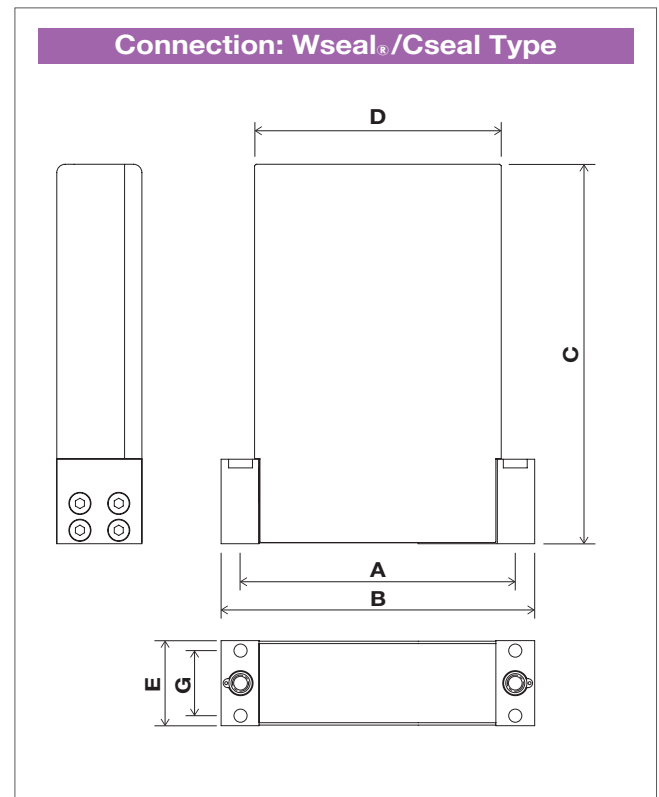
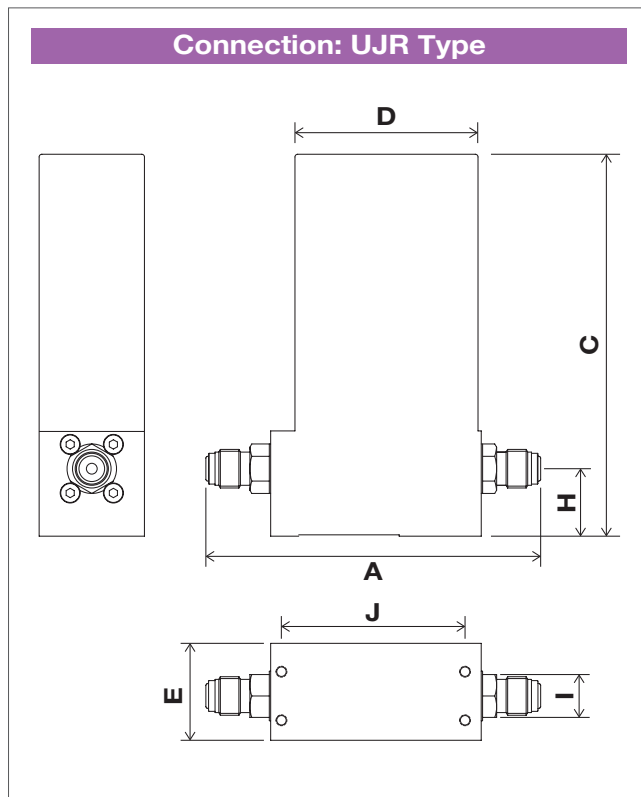
FLOW CONTROL SYSTEM	①	②	③	④	⑤	⑥	⑦	⑧	⑨
	① Series		③ Control range		⑤ Full scale		⑦ Gas name	⑧ Bin No.	⑩ Function
	② Communication E: EtherCAT [®]		W2: Wide range 200 Torr or less	④ Fitting type, face-to-face dimension or seal pitch 4TW1: 10 mm, OneWseal [®] Seal pitch: 77 mm	F20: 20 SCCM FIL: 1 SLM		Chemical formula	B1: 10-20 SCCM B2: 21-40 SCCM B3: 41-80 SCCM B4: 81-160 SCCM B5: 161-300 SCCM B6: 301-600 SCCM B7: 601-1000 SCCM (N ₂ Equivalent)	E**: Numerals are entered in "****".

FCSP8502

FCS P8502 D W4 - 4CC2 - F3200 / N2 - D **

FLOW CONTROL SYSTEM	①	②	③	④	⑤	⑥	⑦	⑧
	① Series		③ Control range		⑤ Fitting type, face-to-face dimension or seal pitch		⑦ Gas name	
	② Communication D: DeviceNet™ E: EtherCAT [®]		W4: Wide range 400 Torr	④ Accuracy guaranteed temperature range None: 15 - 50 °C	4CC2: 1.125, Cseal Seal pitch: 92 mm		Chemical formula	⑧ Function D**: E**: Numerals are entered in "****".

Dimensions



UJR Type

Model Number	A	C	D	E	H	I	J
P7000 (WR)	124	141.5	67.8	39	25	25	68
UPC®	106/124	128	70.5	28.1	25	18	—

1.5Wseal® Type

Model Number	A	B	C	D	E	G
P7000 (WR)	79.8	93	141.5	67.8	39	30
UPC®	79.8	93	128	70.5	39	30

1.125Wseal® Type

Model Number	A	B	C	D	E	G
P7000/P8000	92	105	127	82.6	28.5	21.8
UPC®/UPCUS®	92	105	128	70.5	28.5	21.8

1.125Cseal Type

Model Number	A	B	C	D	E	G
P8000	92	105	127	83	28.5	21.8

FCS[®]-Thermal Series

Product Line-UP

Series			Mass Flow Controller				
							
Features			PI Function Model •Equipped with built-in pressure sensor •Insensitive to sudden pressure fluctuations (Pressure insensitive) •With MGMR function •Corrosion resistant Hastelloy sensor •Flow rate accuracy: Within ±1.0 % S.P.	MGMR Model •MGMR (Multi Gas / Multi Range) function •Corrosion resistant Hastelloy sensor •Flow rate accuracy: Within ±1.0 % S.P.	Standard Digital Model •Flow rate accuracy: ±1.0 % F.S. •All flow rate areas: Response time ≤ 1 sec •24V drive model •Supports special specifications	High Flow Rate Model •Max. flow rate 1000 SLM (1000 SLM: Limited to certain gases) •Flow rate accuracy: ±1.0 % F.S. •Response time: ≤ 3 sec	High Temperature Model •50 ~ 80 °C (Please consult Fujikin for use at temperatures above 80 °C.)
Series Name			FCS-T1000MP	FCS-T1000Z	FCS-T1000F	FCS-T1200F FCS-T1500F	FCS-T1000M (Z) F-HT FCS-T1200MF-HT
Flow Rate Range (N ₂ Equivalent)			10 SCCM ~ 50 SLM	10 SCCM ~ 50 SLM	10 SCCM ~ 50 SLM	51 ~ 1000 SLM	10 SCCM ~ 200 SLM
Seal Material			Metal	Metal Rubber	Metal Rubber	Metal Rubber	Metal
Flow Rate Accuracy			±1.0 % S.P. (25-100 %) ±0.25 % F.S. (2~25 %)	±1.0 % S.P. (25-100 %) ±0.25 % F.S. (2~25 %)	±1.0 % F.S.	±1.0 % F.S. (T1200) ±2.0 % F.S. (T1500)	±1.0 % S.P. (25-100 %) (T1000MZ) ±0.25 % F.S. (2-25 %) (T1000MZ) ±1.0 % F.S. (2-100 %) (T1000MF, T1200MF)
Response Time			≤1 sec	≤1 sec	≤1 sec	≤3 sec	≤1 sec (10 SCCM~50 SLM) ≤3 sec (51~150 SLM)
PI Function			PI				
MGMR Function			MGMR	MGMR	MR MG ※1		
Communication System	Analog	±15V drive (0 ~ 5 VDC)	±15V drive (0 ~ 5 VDC)	±15V drive (0 ~ 5 VDC)	±15V drive (0 ~ 5 VDC)	±15V drive (0 ~ 5 VDC)	±15V drive (0 ~ 5 VDC)
		+24V drive (0 ~ 5 VDC)		+24V drive (0 ~ 5 VDC)	+24V drive (0 ~ 5 VDC)	+24V drive (0 ~ 5 VDC) For rubber type only	+24V drive (0 ~ 5 VDC) For T1000 only
		+24V drive (4 ~ 20 mA)		+24V drive (4 ~ 20 mA)	+24V drive (4 ~ 20 mA)	+24V drive (4 ~ 20 mA) For rubber type only	+24V drive (4 ~ 20 mA) For T1000 only
	Digital	RS485	RS485	RS485	RS485	RS485	RS485
		DeviceNet™	DeviceNet™	DeviceNet™	DeviceNet™	DeviceNet™	DeviceNet™ For T1000MF only
		EtherCAT®	EtherCAT®	EtherCAT® For metal type only	EtherCAT®	EtherCAT®	EtherCAT®
		PROFIBUS			PROFIBUS		
	CC-Link			CC-Link	CC-Link	CC-Link	
Fittings	Union Gasket Type (UJR Type)		1/4 UJR	1/4 UJR	1/4 UJR	3/8 UJR (T1200) 1/2 UJR (T1500)	1/4 UJR (T1000M) 3/8 UJR (T1200MF)
	Double Compression Ring Type (F900 Type)		—	1/4 F900	1/4 F900	3/8 F900 (T1200) 1/2 F900 (T1500)	1/4 F900 (T1000M) 3/8 F900 (T1200MF)
	Integrated System Type (IGS® Type)		1.5 Wseal _® 1.125 Wseal _® 1.125 Cseal	1.5 Wseal _® 1.125 Wseal _® 1.125 Cseal	1.5 Wseal _® 1.125 Wseal _® 1.125 Cseal	—	1.5 Wseal _® 1.125 Wseal _® 1.125 Cseal
Surface Finish			EP	EP For metal type only	EP For metal type only	EP For metal type only	EP Option
Compatible with RoHS			RoHS	RoHS	RoHS	RoHS	RoHS
Mass Flow Meter				Mass Flow Meter	Mass Flow Meter	Mass Flow Meter	Mass Flow Meter For T1000 only

*1: MR specifications: Changeable to 1/3 flow of the specified full scale flow. MG specifications: Up to four kinds of gases and flow rates can be registered.

*2: Analog interface: D-sub 9 pin Note that TM39 HRS-made HR10A-7R-6P UPC_® or UPCUS_® has half pitch 20 P.

*3: Digital interface: For RS485 communications, FCS-T1000 Series has RJ11 connector; FCS-T2000 Series has RJ45 connector.

Note 1: External leak rate: Metal seal: 1×10^{-11} Pa·m³/sec He, Rubber Seal: 1×10^{-7} Pa·m³/sec He

Note 2: Please consult Fujikin for use under other conditions.

Note 3: DeviceNet™ is a registered trademark of the Open DeviceNet Vendor Association, Inc.

Note 4: PROFIBUS is a registered trademark of the PROFIBUS Organization.

Note 5: EtherCAT_® is a registered trademark and patented technology, licensed by Beckhoff Automation GmbH, Germany.

Note 6: CC-Link is a registered trademark of the CC-Link Partner Association.

